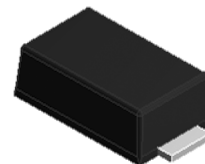


Features

- Schottky barrier diodes
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 260 °C, 10 s
- Low profile, typical thickness 1.0mm
- AEC-Q101 qualified



eSGB (SMAF)

Typical Applications

For use in low voltage,high frequency inverters,free wheeling, and polarity protection application

Maximum Ratings (TA = 25 °C unless otherwise noted)

Parameter	Symbol	LSL3B	Unit
Maximum repetitive peak reverse voltage	VRRM	100	V
Maximum RMS voltage	VRMS	70	V
Maximum DC blocking voltage	VDC	100	V
Maximum average forward rectified current at TL (See Fig.1)	IF(AV)	3.0	A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	IFSM	100	A
Operating junction and storage temperature range	TJ, TSTG	- 55 to + 150	°C

Electrical Characteristics (TA = 25 °C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Instantaneous forward voltage	IF=1A, TA=25℃	VF	-	0.53	0.60	Volts
	IF=2A, TA=25℃		-	0.62	0.70	
	IF=3A, TA=25℃		-	0.68	0.75	
	IF=3A, TA=100℃		-	0.59	-	
Maximum DC reverse current at rated DC blocking voltage	TA=25℃	IR	0.2			mA
	TA=100℃		20			
Typical junction capacitance	4.0 V, 1 MHz	C _J	140			pF
Typical thermal resistance ¹⁾	junction to lead	R _{θJL}	20			℃/W

Note1: Thermal resistance from junction to lead,mounted on PCB with 8.0×8.0mm copper pads

Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

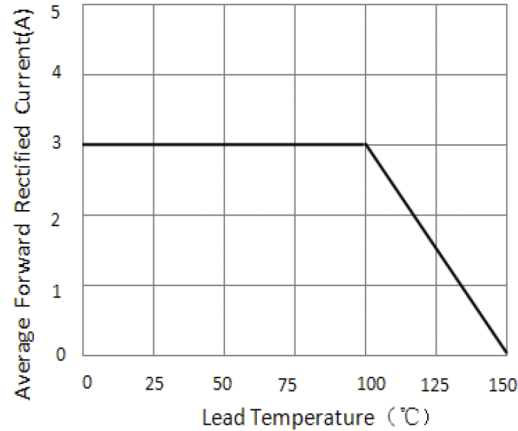


Figure 1. Forward Current Derating Curve

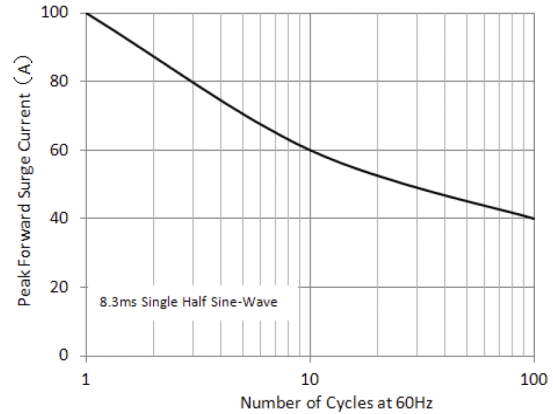


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

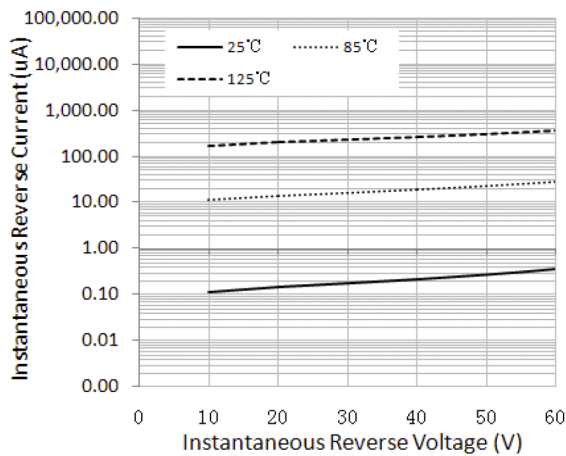


Figure 3. Typical Reverse Characteristics

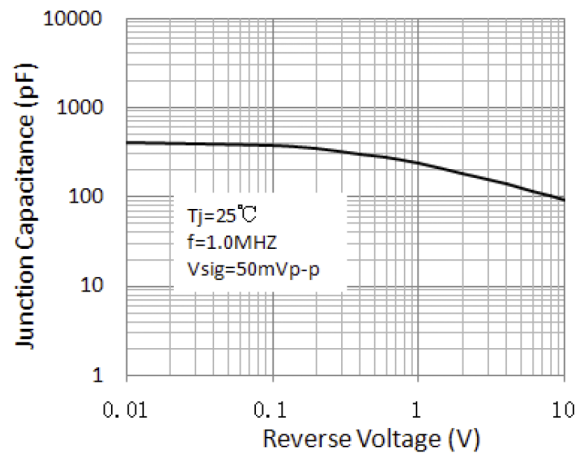


Figure 4. Typical Junction Capacitance

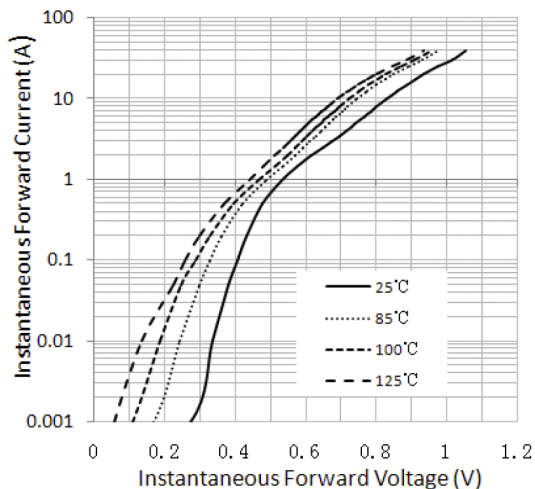
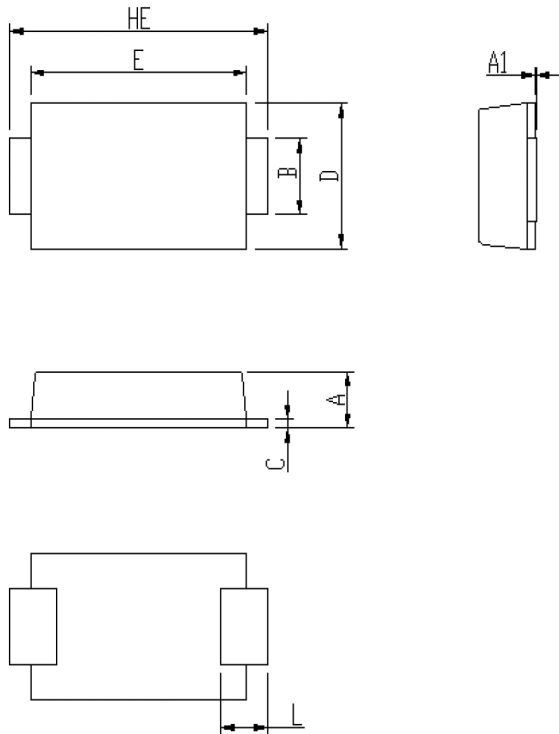


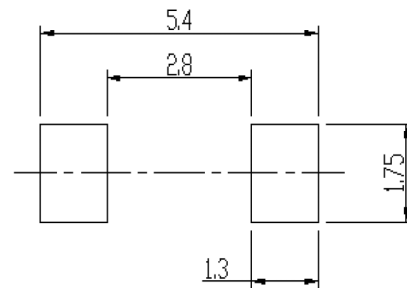
Figure 5. Typical Instantaneous Forward Characteristics

Package Outline Dimensions



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.92	1.08	0.036	0.043
A1	0	0.1	0.000	0.004
B	1.25	1.45	0.049	0.057
C	0.1	0.25	0.004	0.010
D	2.6	2.8	0.102	0.110
E	4.1	4.3	0.161	0.169
L	0.7	1.1	0.028	0.043
HE	4.8	5.2	0.189	0.205

Soldering footprint



Packing Information

Packing quantities:

Reel size	Quantity/reel	Quantity/inner Box	Quantity/Carton
7"	3K	21K	84K
13"	10K	20K	180K

Tape & Reel Specification

